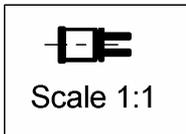
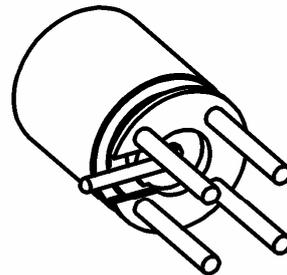
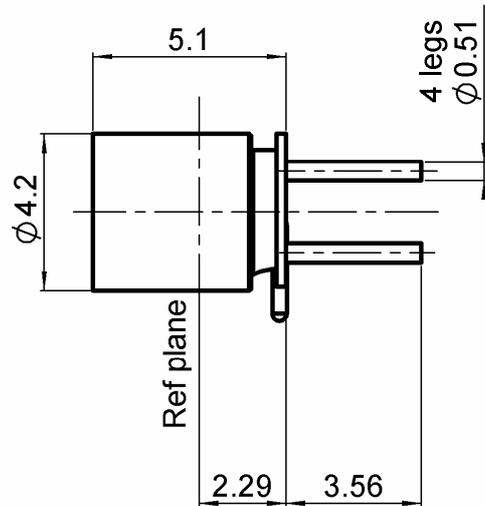
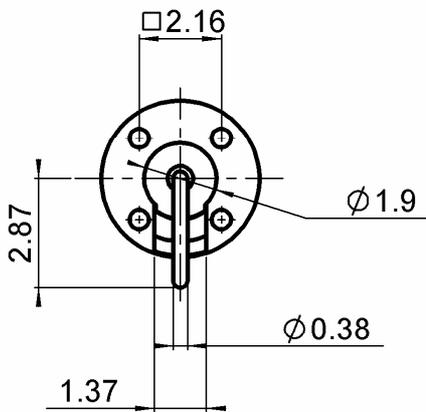


**MALE STRAIGHT RECEPTACLE FOR PCB**

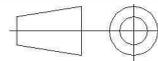
**R222.428.000**

**PIN IN PASTE - FULL DETENT**

Series : SMP



All dimensions are in mm.



COMPONENTS	MATERIALS	PLATINGS (µm)
BODY	STAINLESS STEEL + BRASS	PASSIVATED + GOLD 0.5 OVER NICKEL 2
CENTER CONTACT	BERYLLIUM COPPER	GOLD 1.27 OVER NICKEL 1.27
OUTER CONTACT	-	-
INSULATOR	PTFE	-
GASKET	-	-
OTHERS PARTS	-	-
-	-	-
-	-	-

Issue : 0914 C

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



**MALE STRAIGHT RECEPTACLE FOR PCB**

**R222.428.000**

**PIN IN PASTE - FULL DETENT**

Series : SMP

**PACKAGING**

**SPECIFICATION**

Standard	Unit	Other
<b>100</b>	<b>'W' option</b>	<b>Contact us</b>

**ELECTRICAL CHARACTERISTICS**

**ENVIRONMENTAL**

Impedance	<b>50</b>	$\Omega$
Frequency	<b>0-18</b>	GHz
VSWR	<b>1.15*</b> + <b>0,0000</b>	x F(GHz) Maxi
Insertion loss	<b>0.12</b>	$\sqrt{F}$ (GHz) dB Maxi
RF leakage	- ( <b>NA</b> )	- F(GHz)) dB Maxi
Voltage rating	<b>335</b>	Veff Maxi
Dielectric withstanding voltage	<b>500</b>	Veff mini
Insulation resistance	<b>5000</b>	M $\Omega$ mini

Operating temperature	<b>-65/+165</b>	$^{\circ}$ C
Hermetic seal	<b>NA</b>	Atm.cm3/s
Panel leakage	<b>NA</b>	

**OTHERS CHARACTERISTICS**

Assembly instruction

Others :

Compliant with MIL-STD-348

\*At 12,4 GHz - Performance strongly depends on lay out and pcb material

**MECHANICAL CHARACTERISTICS**

Axial force – Mating end	<b>6.8</b>	N mini
Axial force – Opposite end	<b>6.8</b>	N mini
Torque		N.cm mini

Recommended torque

Mating	<b>NA</b>	N.cm
Panel nut	<b>NA</b>	N.cm

Mating life	<b>100</b>	Cycles mini
Weight	<b>0,3500</b>	g

Issue : 0914 C

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**MALE STRAIGHT RECEPTACLE FOR PCB**

**R222.428.000**

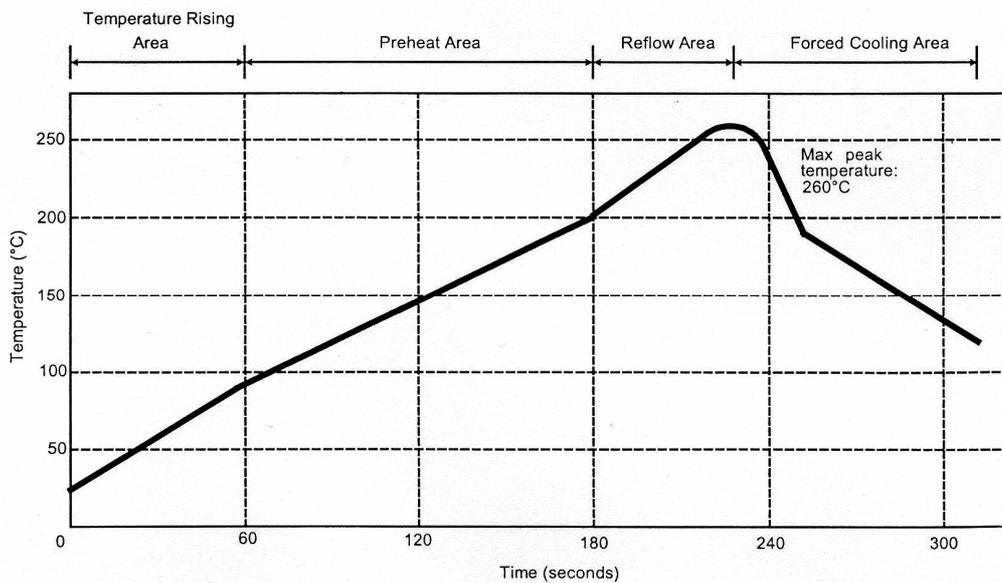
**PIN IN PASTE - FULL DETENT**

Series : SMP

**SOLDER PROCEDURE**

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.  
We advise a thickness of 150 microns ( 5.85 microinch ). Verify that the edges of the zone are clean.
2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.  
Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
3. Soldering by infra-red reflow.  
Below, please find the typical profile to use.
4. Cleaning of printed circuit boards.
5. Checking of solder joints and position of the component by visual inspection.

**TEMPERATURE PROFILE**



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec

Issue : 0914 C

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**MALE STRAIGHT RECEPTACLE FOR PCB**

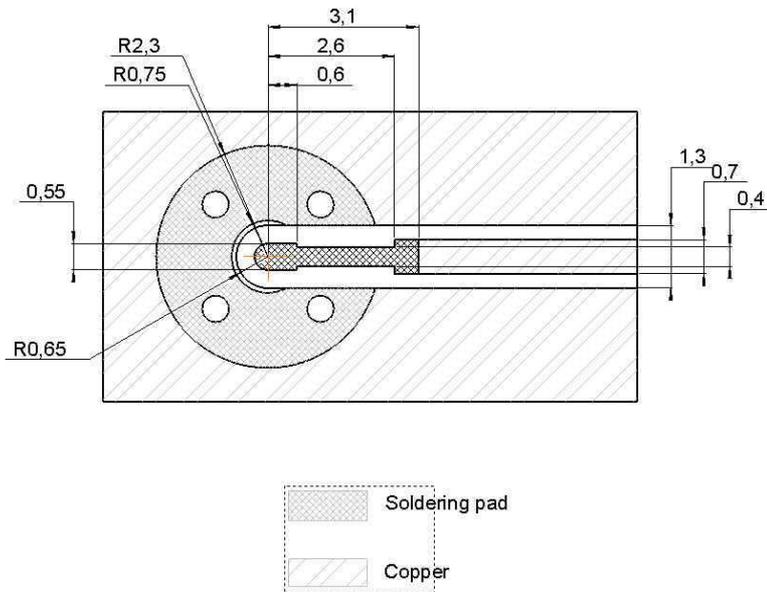
**R222.428.000**

**PIN IN PASTE - FULL DETENT**

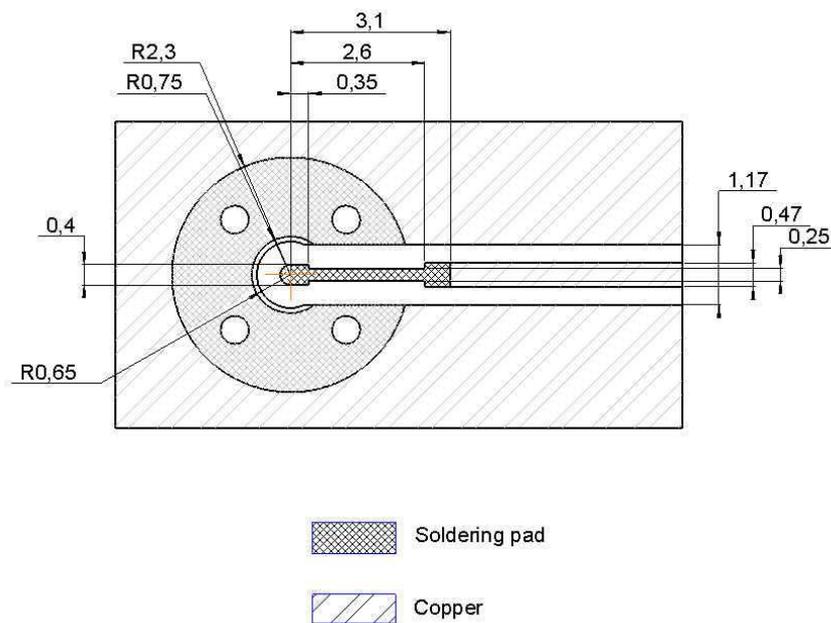
Series : SMP

**RECOMMENDED PAD DIMENSIONS:**

Substrate: RT5880 thickness 0.254mm, with copper layer 35µm on both sides :  
 Add vias between both sides along upper ground plane according to engineering practise



Substrate: RO4350 thickness 0.254mm, with copper layer 35µm on both sides :  
 Add vias between both sides along upper ground plane according to engineering practise



Issue : 0914 C

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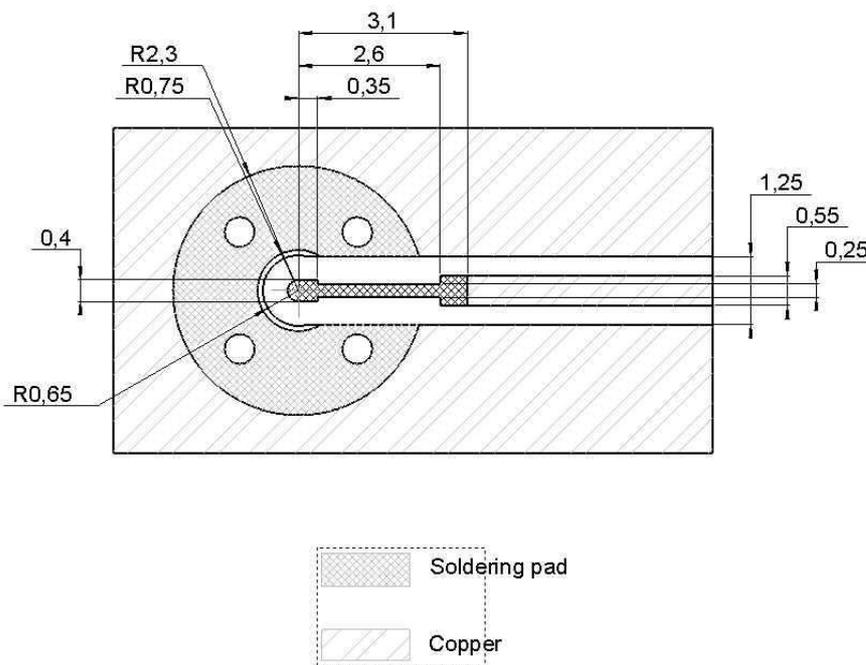
**MALE STRAIGHT RECEPTACLE FOR PCB**

**R222.428.000**

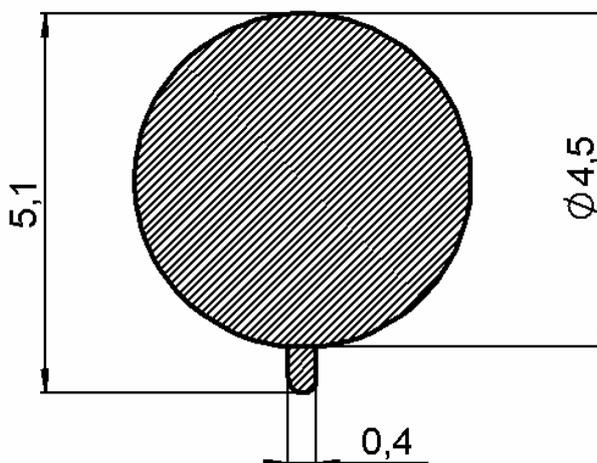
**PIN IN PASTE - FULL DETENT**

Series : SMP

Substrate: RO6002 thickness 0.254mm, with copper layer 35µm on both sides :  
 Add vias between both sides along upper ground plane according to engineering practise



**SHADOW FOR VIDEO CAMERA**



Issue : 0914 C

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## Данный компонент на территории Российской Федерации

### Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9